

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-100V	36mΩ@-10V	-25A
	51mΩ@-4.5V	

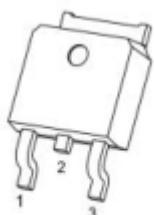
Feature

- Fast Switching
- Low On-Resistance
- Excellent FOM

Application

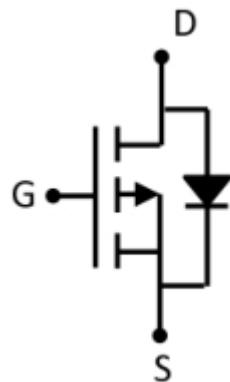
- Motor control
- Switching Regulators
- Isolated DC/DC convertor
- Alertor

Package



TO-252(1:G 2:D 3:S)

Circuit diagram



Marking



010P36G =Device Code
****** =Week Code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

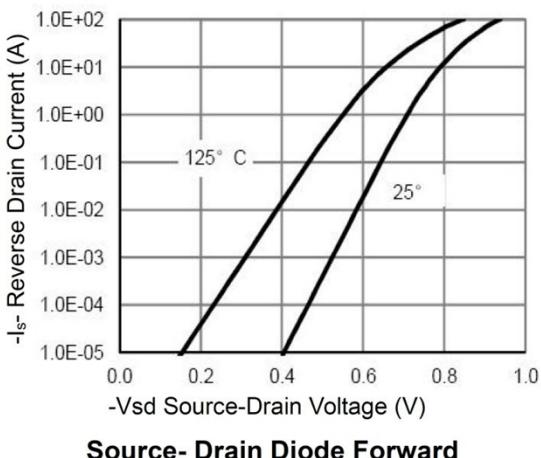
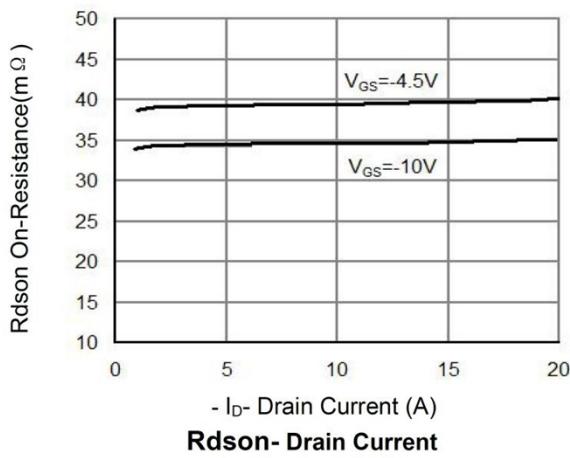
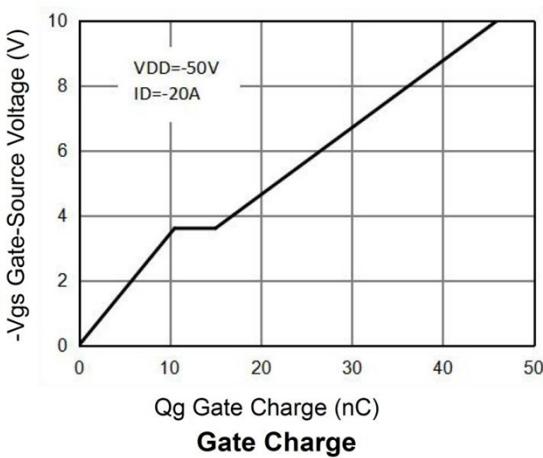
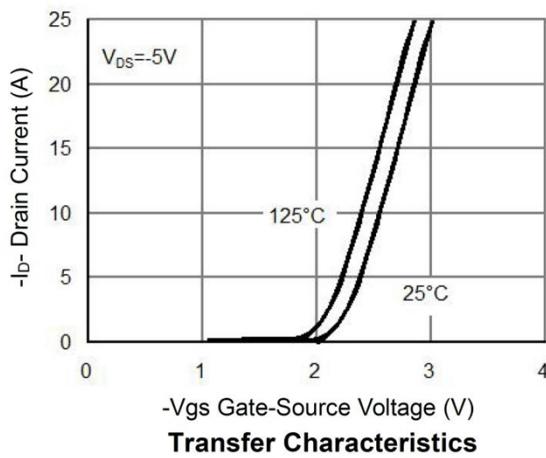
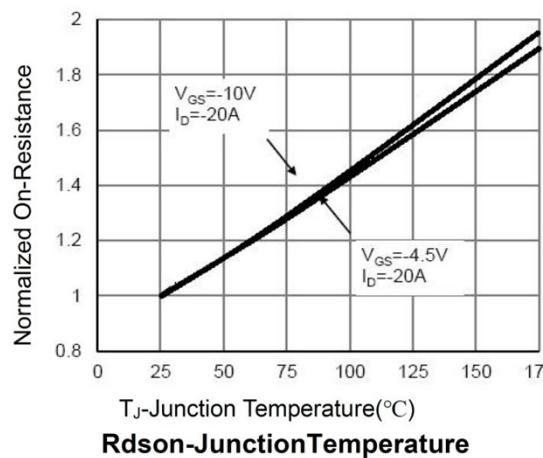
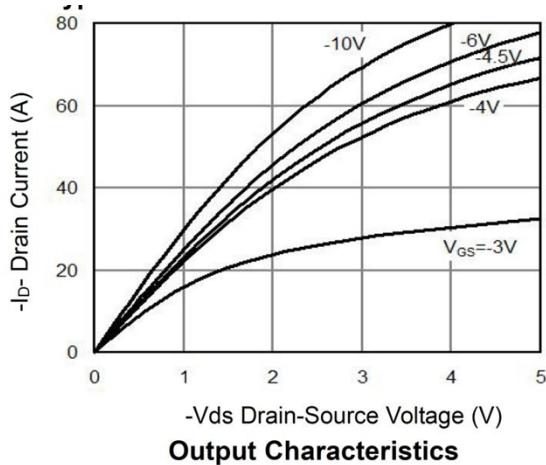
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	-25	W
Drain Current – Pulsed ¹	I_{DM}	-100	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	120	W
Thermal Resistance Junction to Case	$R_{\theta JC}$	1.04	$^\circ\text{C} / \text{W}$
Storage Temperature Range	T_{STG}	-55 ~ +150	$^\circ\text{C}$
Operating Junction Temperature Range	T_J	-55 ~ +150	$^\circ\text{C}$

Electrical characteristics

($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-100			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = -100\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	μA
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1	-2.2	-3	V
Static Drain-Source on-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -10\text{V}, I_D = -15\text{A}$		36	45	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -10\text{A}$		51	68	
Dynamic characteristics⁴						
Total Gate Charge	Q_g	$V_{\text{GS}} = -10\text{V}, V_{\text{DS}} = -50\text{V}, I_D = -15\text{A}$		20		nC
Gate-Source Charge	Q_{gs}			6.1		
Gate-Drain Charge	Q_{gd}			3.5		
Turn-On Delay Time	$T_{\text{d(on)}}$	$V_{\text{GS}} = -10\text{V}, V_{\text{DD}} = -50\text{V}, I_D = -15\text{A}, R_{\text{GEN}} = 6\Omega$		11		nS
Rise Time	T_r			56		
Turn-Off Delay Time	$T_{\text{d(off)}}$			46		
Fall Time	T_f			84		
Input Capacitance	C_{iss}	$V_{\text{DS}} = -50\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1415		pF
Output Capacitance	C_{oss}			217		
Reverse Transfer Capacitance	C_{rss}			3		
Drain-Source Diode Characteristics						
Continuous Source Current	I_s	$V_G = V_D = 0\text{V}$, Force Current			-30	A
Diode forward voltage	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = -1\text{A}$			-1.2	V

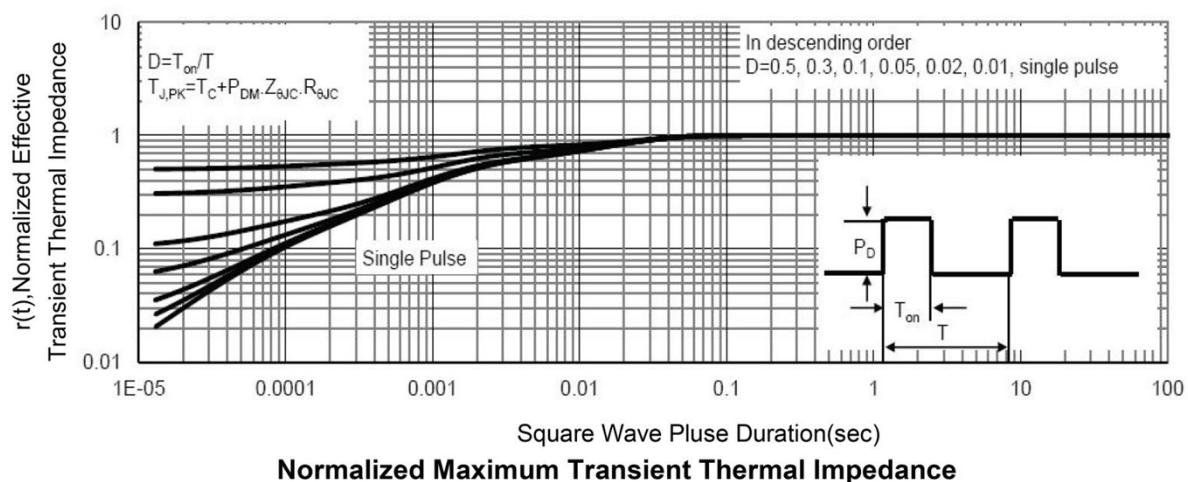
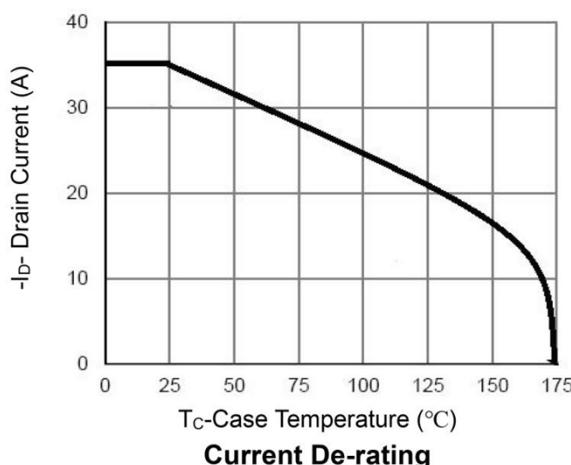
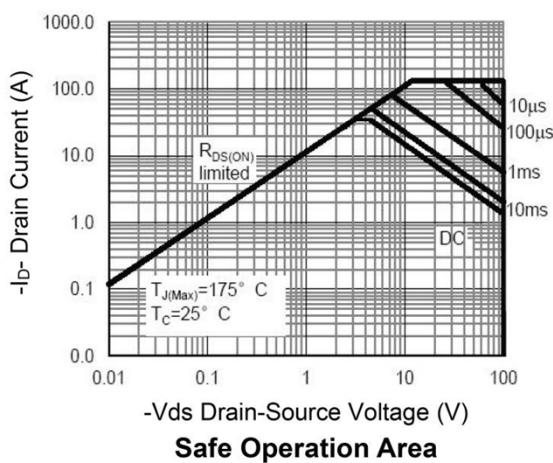
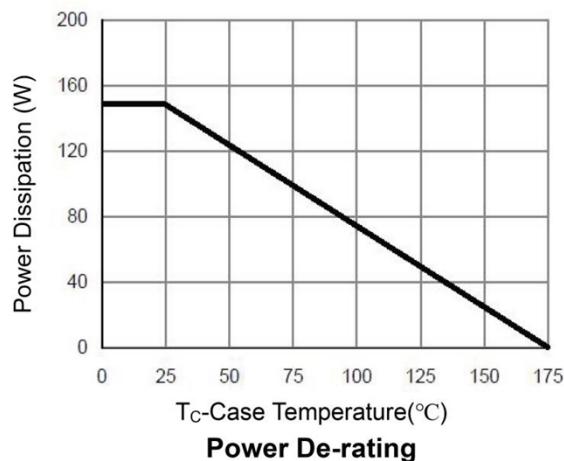
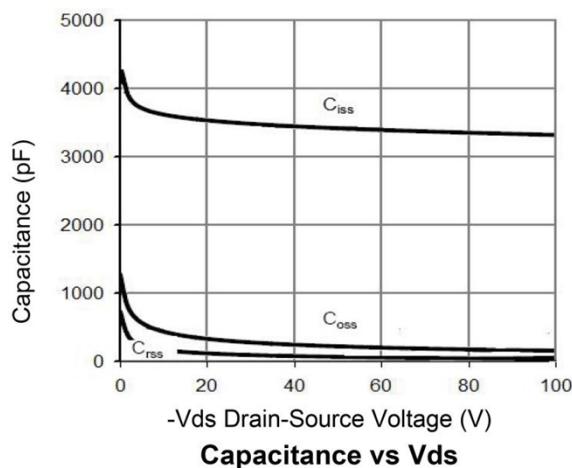
Typical Characteristics



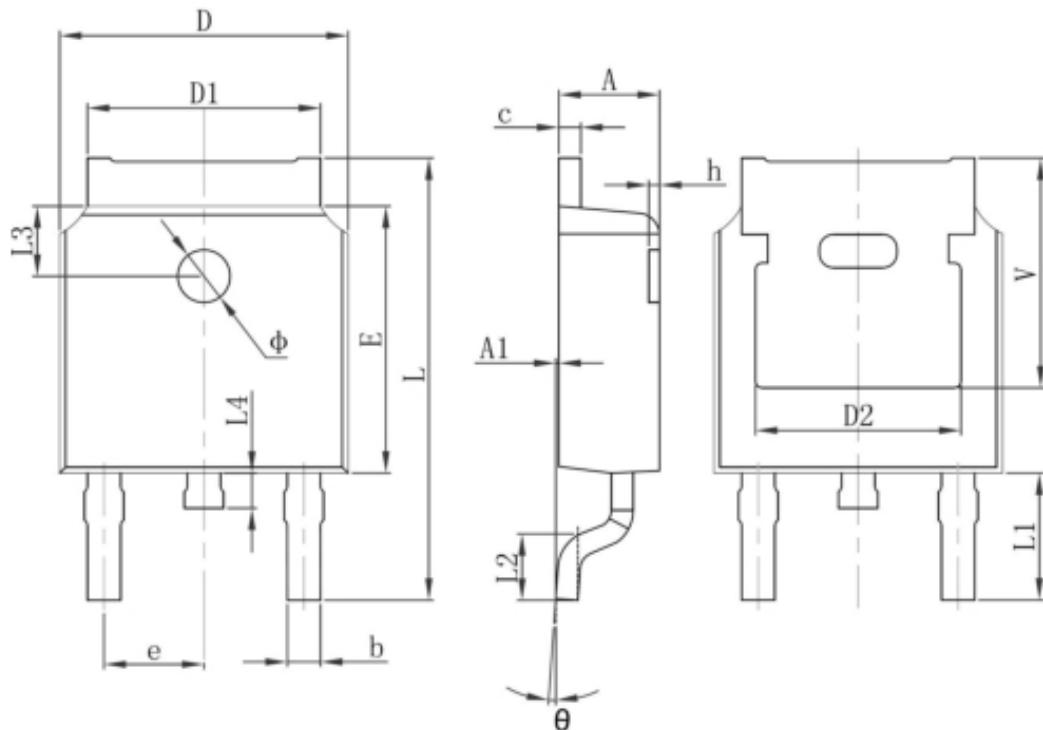


ZL MOSFET

ZL010P36G



TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	